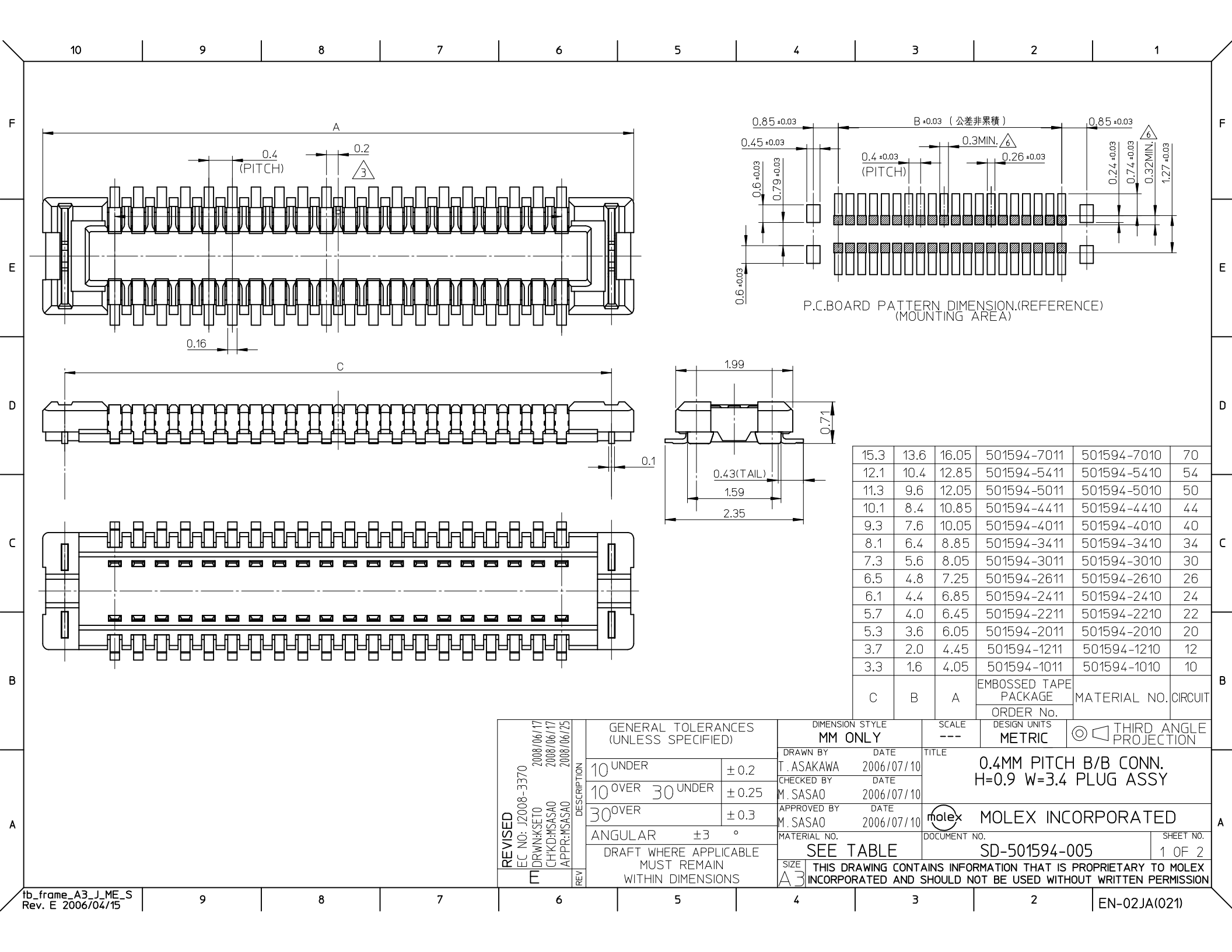




THE DATASHEET OF

501594-1211



P.C.BOARD PATTERN DIMENSION.(REFERENCE)
(MOUNTING AREA)

15.3	13.6	16.05	501594-7011	501594-7010	70
12.1	10.4	12.85	501594-5411	501594-5410	54
11.3	9.6	12.05	501594-5011	501594-5010	50
10.1	8.4	10.85	501594-4411	501594-4410	44
9.3	7.6	10.05	501594-4011	501594-4010	40
8.1	6.4	8.85	501594-3411	501594-3410	34
7.3	5.6	8.05	501594-3011	501594-3010	30
6.5	4.8	7.25	501594-2611	501594-2610	26
6.1	4.4	6.85	501594-2411	501594-2410	24
5.7	4.0	6.45	501594-2211	501594-2210	22
5.3	3.6	6.05	501594-2011	501594-2010	20
3.7	2.0	4.45	501594-1211	501594-1210	12
3.3	1.6	4.05	501594-1011	501594-1010	10
C	B	A	EMBOSSD TAPE PACKAGE	MATERIAL NO.	CIRCUIT
			ORDER No.		

REVISED EC NO: J2008-3370 2008/06/17 DRW:KSE10 2008/06/17 CHKD:MSASAO 2008/06/25 APPR:MSASAO	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
		10 UNDER	± 0.2	DRAWN BY T. ASAKAWA	DATE 2006/07/10	TITLE 0.4MM PITCH B/B CONN. H=0.9 W=3.4 PLUG ASSY				
		10 OVER 30 UNDER	± 0.25	CHECKED BY M. SASAO	DATE 2006/07/10					
		30 OVER	± 0.3	APPROVED BY M. SASAO	DATE 2006/07/10	MOLEX INCORPORATED				
		ANGULAR ±3 °		MATERIAL NO.						
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE TABLE		SD-501594-005		1 OF 2			
	REV			SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					

F

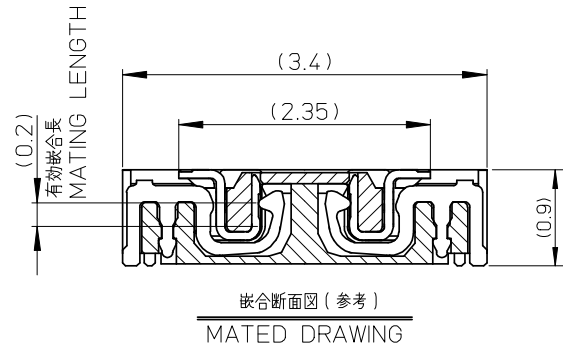
E

D

C

B

A



注記 NOTES

1.使用材料
MATERIAL

ハウジング : 液晶ポリマー (LCP) ガラス充填 UL-94V-0 (黒)
HOSING : LIQUID CRYSTAL POLYMER (GLASS FILLED) UL94V-0 (COLOR:BLACK)

ターミナル : りん青銅 ($t=0.08$)
TERMINAL : PHOSHOR BRONZE ($t=0.08$)

金具 : りん青銅 ($t=0.1$)
FITTING NAIL : PHOSHOR BRONZE ($t=0.1$)

2.メッキ仕様
PLATING

ターミナル
TERMINAL

金メッキ 0.1マイクロメートル以上 (コンタクト部)
GOLD 0.1 MICROMETER MINIMUM (CONTACT AERA)

金メッキ 0.03マイクロメートル以上 (テール部)
GOLD 0.03 MICROMETER MINIMUM (TAIL AERA)

下地メッキ : ニッケルメッキ 1.0 マイクロメートル以上
UNDER PLATING : NICKEL 1.0 MICROMETER MINIMUM

金具
FITTING NAIL

錫メッキ : 1.0マイクロメートル以上
TIN PLATING : 1.0 MICROMETER MINIMUM

下地メッキ : ニッケル1.0マイクロメートル以上
UNDER PLATING :NICKEL 1.0 MICROMETER MINIMUM

3. (全極数/2)=偶数の場合に適用
APPLY FOR (CIRCUIT/2)=EVEN

4.嵌合相手 : 501591-**10シリーズ
WITH MATE : 501591-**10SERIES

5.テール及び金具の平坦度は、0.1以下
TAIL AND FITTING NAIL COPLANARITY TO BE 0.1 MAXIMUM

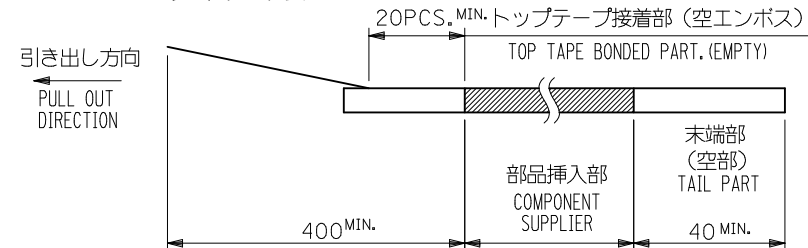
6.斜線部はパターン書き込み禁止範囲と半田禁止範囲を示す。
ただし、斜線部に同一配線を配置する場合はレジストを施し、この部分に半田は無きこと。
NO PATTERN CIRCUIT AND NO SOLDER ALLOWED IN THE SHADED AREA.
HOWEVER, IF NEEDED TO ADD A TRACE OF THE SAME CIRCUIT, PUT THE SOLDER-RESIST,
YET NO SOLDER ALLOWED IN THE AREA.

7.ELV AND RoHS COMPLIANT.

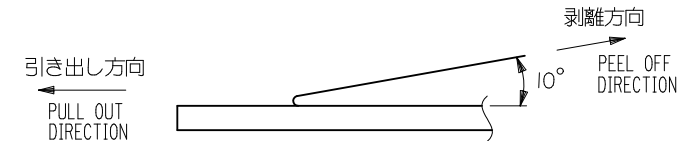
REVISED EC NO: J2008-3370 DRWN:KSETO 2008/06/17 CHKD:MSAO 2008/06/17 APPR:MSAO 2008/06/25	DESCRIPTION REV	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
		10 UNDER	± 0.2	T. ASAKAWA	DATE 2006/07/10	TITLE 0.4MM PITCH B/B CONN. H=0.9 W=3.4 PLUG ASSY				
		10 OVER 30 UNDER	± 0.25	M. SASAO	DATE 2006/07/10					
		30 OVER	± 0.3	APPROVED BY M. SASAO	DATE 2006/07/10	MOLEX INCORPORATED				
		ANGULAR ± 3 °		MATERIAL NO.		DOCUMENT NO.		SHEET NO.		
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE SHEET 1		SD-501594-005		2 OF 2		
				SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					

NOTES

- 製品詳細寸法については製品単体図面を参照下さい。
RE DETAILED DIMENSION, SEE PRODUCT DRAWING.
- 梱包数量 : 3000 個/リール
NUMBER OF CONNECTORS : 3000PCS/REEL
- リードテープ長さ LEAD TAPE LENGTH



- トップテープの剥離強度 : JES-59 参照
剥離方向は下図参照。
PEELING OFF STRENGTH OF TOP TAPE : REFER TO JES-59
PEELING DIRECTION AS SHOWN IN FOLLOWING FIGURE.



- 材料 MATERIAL
キャリアテープ (CARRIER TAPE) : ポリスチレン (POLYSTYRENE)
トップテープ (TOPTAPE) : PET , PE , PEF
リール (REEL) : ポリスチレン (PS) <リサイクル材を含む>
POLYSTYRENE (PS) <RECYCLE MATERIAL CONTAINED>

6.ELV AND RoHS COMPLIANT.

REVISED EC NO: J2012-0023 2011/07/05 DRW:KTOYODA 2011/07/06 CHKD:TASAKAWA 2011/11/30 APPR:MSASAO	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC		THIRD ANGLE PROJECTION
		10 UNDER	± 0.2	DRAWN BY TASAKAWA	DATE 2006/07/10	TITLE 0.4MM PITCH B/B CONN. PLUG ASSY (HGT=0.9) EMBSTP PKG		MOLEX INCORPORATED	
		10 OVER 30 UNDER	± 0.25	CHECKED BY MSASAO	DATE 2006/07/10				
		30 OVER	± 0.3	APPROVED BY MSASAO	DATE 2006/07/10				
		ANGULAR ±3 °		MATERIAL NO.		DOCUMENT NO.			SHEET NO.
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE SHEET 1		SD-501594-006				1 OF 2
	REV	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION							

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